

# MP4210

High Power, High Speed Switching Applications  
 For Printer Head Pin Driver and Pulse Motor Driver  
 For Solenoid Driver

- 4 V gate drive available
- Small package by full molding (SIP 10 pin)
- High drain power dissipation (4 devices operation)  
 : P<sub>T</sub> = 4 W (T<sub>a</sub> = 25°C)
- Low drain-source ON resistance: R<sub>DS (ON)</sub> = 0.12 Ω (typ.)
- High forward transfer admittance: |Y<sub>fs</sub>| = 5.0 S (typ.)
- Low leakage current: I<sub>GSS</sub> = ±10 μA (max) (V<sub>GS</sub> = ±16 V)  
 I<sub>DSS</sub> = 100 μA (max) (V<sub>DS</sub> = 60 V)
- Enhancement-mode: V<sub>th</sub> = 0.8 to 2.0 V (V<sub>DS</sub> = 10 V, I<sub>D</sub> = 1 mA)

### Maximum Ratings (T<sub>a</sub> = 25°C)

Characteristics		Symbol	Rating	Unit
Drain-source voltage		V <sub>DSS</sub>	60	V
Drain-gate voltage (R <sub>GS</sub> = 20 kΩ)		V <sub>DGR</sub>	60	V
Gate-source voltage		V <sub>GSS</sub>	±20	V
Drain current	DC	I <sub>D</sub>	5	A
	Pulse	I <sub>DP</sub>	20	
Drain power dissipation (1 device operation, T <sub>a</sub> = 25°C)		P <sub>D</sub>	2.0	W
Drain power dissipation (4 devices operation, T <sub>a</sub> = 25°C)		P <sub>DT</sub>	4.0	W
Single pulse avalanche energy (Note 1)		E <sub>AS</sub>	129	mJ
Avalanche current		I <sub>AR</sub>	5	A
Repetitive avalanche energy (Note 2)	1 device operation	E <sub>AR</sub>	0.2	mJ
	4 devices operation	E <sub>ART</sub>	0.4	
Channel temperature		T <sub>ch</sub>	150	°C
Storage temperature range		T <sub>stg</sub>	-55 to 150	°C

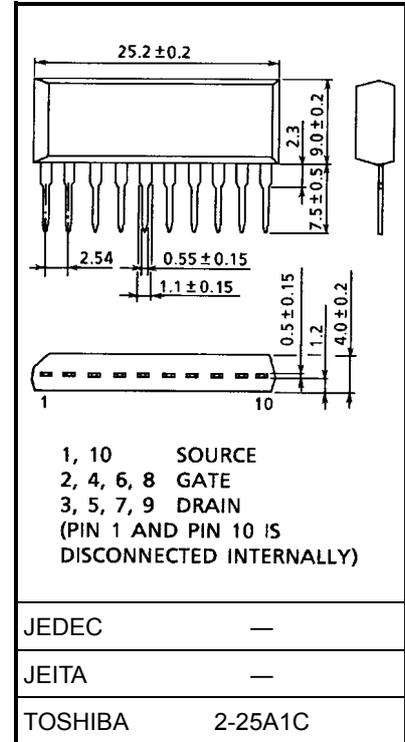
Note 1: Avalanche energy (single pulse) applied condition  
 V<sub>DD</sub> = 25 V, starting T<sub>ch</sub> = 25°C, L = 7 mH, R<sub>G</sub> = 25 Ω, I<sub>AR</sub> = 5 A

Note 2: Repetitive rating; pulse width limited by maximum channel temperature.

This transistor is an electrostatic sensitive device. Please handle with caution.

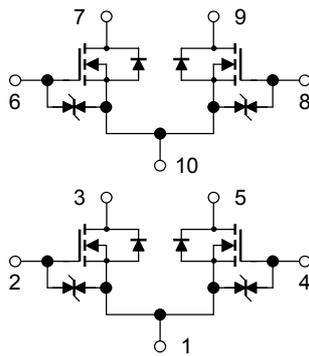
Industrial Applications

Unit: mm



Weight: 2.1 g (typ.)

## Array Configuration



## Thermal Characteristics

Characteristics	Symbol	Max	Unit
Thermal resistance of channel to ambient (4 devices operation, $T_a = 25^\circ\text{C}$ )	$\Sigma R_{th}(\text{ch-a})$	31.2	$^\circ\text{C/W}$
Maximum lead temperature for soldering purposes (3.2 mm from case for $t = 10\text{ s}$ )	$T_L$	260	$^\circ\text{C}$

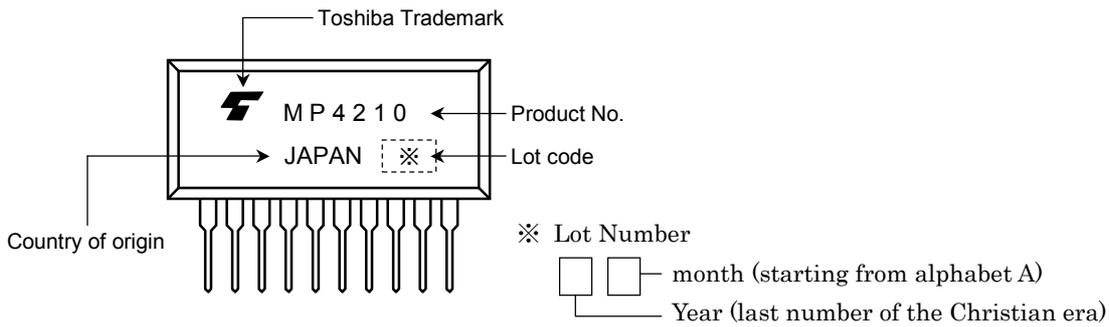
## Electrical Characteristics ( $T_a = 25^\circ\text{C}$ )

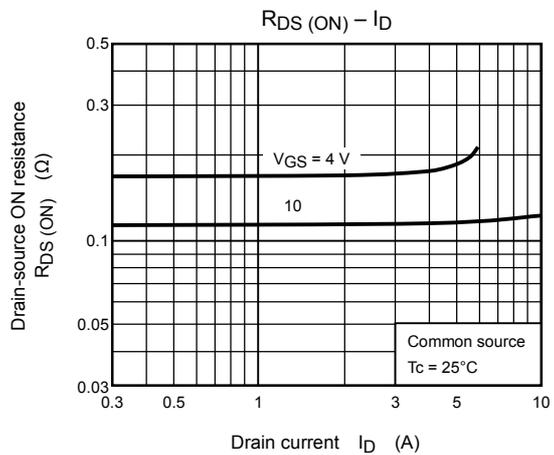
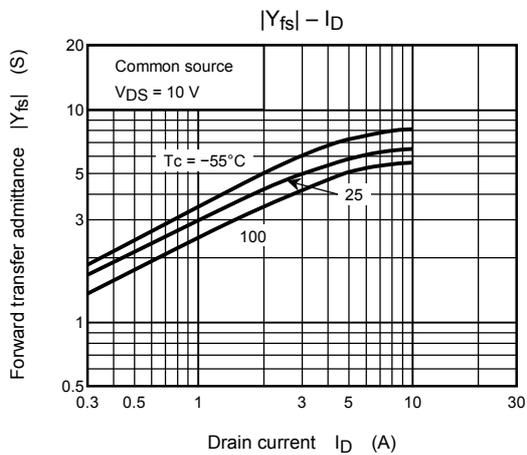
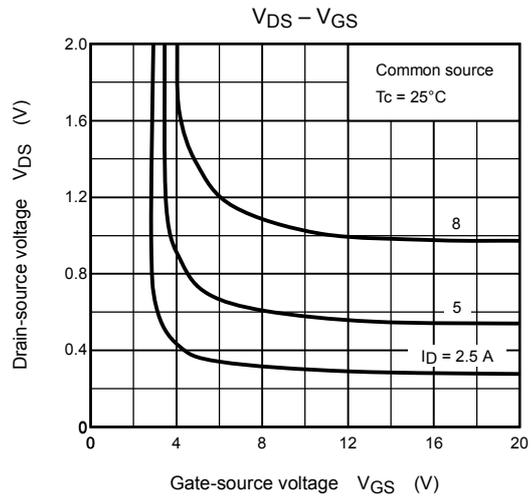
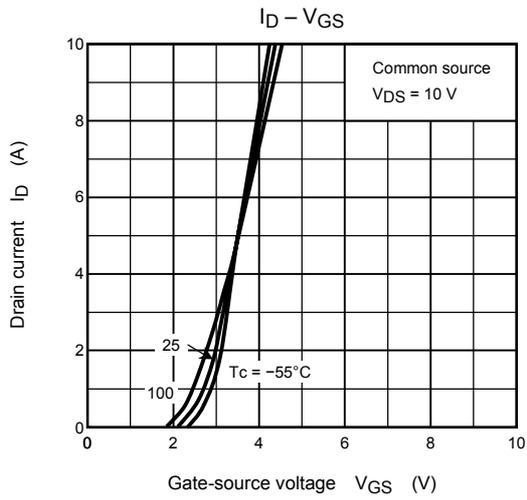
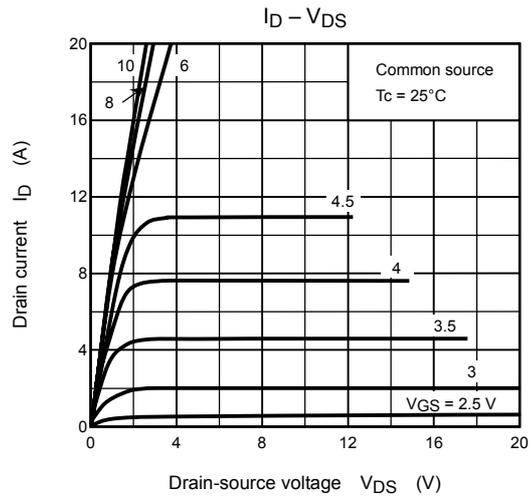
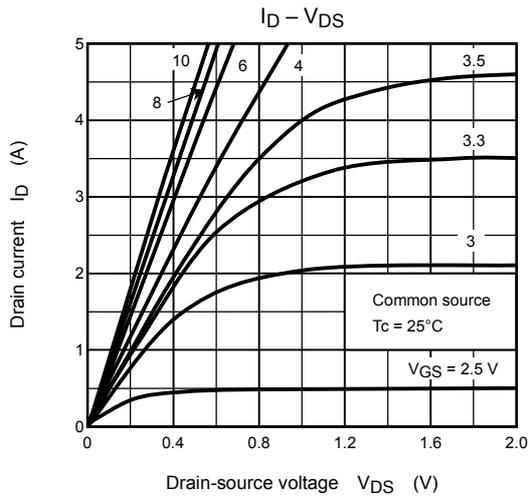
Characteristics		Symbol	Test Condition	Min	Typ.	Max	Unit
Gate leakage current		$I_{GSS}$	$V_{GS} = \pm 16\text{ V}, V_{DS} = 0\text{ V}$	—	—	$\pm 10$	$\mu\text{A}$
Drain cut-off current		$I_{DSS}$	$V_{DS} = 60\text{ V}, V_{GS} = 0\text{ V}$	—	—	100	$\mu\text{A}$
Drain-source breakdown voltage		$V_{(BR)DSS}$	$I_D = 10\text{ mA}, V_{GS} = 0\text{ V}$	60	—	—	V
Gate threshold voltage		$V_{th}$	$V_{DS} = 10\text{ V}, I_D = 1\text{ mA}$	0.8	—	2.0	V
Drain-source ON resistance		$R_{DS(ON)}$	$V_{GS} = 4\text{ V}, I_D = 2.5\text{ A}$	—	0.21	0.32	$\Omega$
			$V_{GS} = 10\text{ V}, I_D = 2.5\text{ A}$	—	0.12	0.16	
Forward transfer admittance		$ Y_{fs} $	$V_{DS} = 10\text{ V}, I_D = 2.5\text{ A}$	3.0	5.0	—	S
Input capacitance		$C_{iss}$	$V_{DS} = 10\text{ V}, V_{GS} = 0\text{ V}$ $f = 1\text{ MHz}$	—	370	—	pF
Reverse transfer capacitance		$C_{rss}$		—	60	—	pF
Output capacitance		$C_{oss}$		—	180	—	pF
Switching time	Rise time	$t_r$		—	18	—	ns
	Turn-on time	$t_{on}$		—	25	—	
	Fall time	$t_f$		—	55	—	
	Turn-off time	$t_{off}$		—	170	—	
Total gate charge (gate-source plus gate-drain)		$Q_g$	$V_{DD} \approx 48\text{ V}, V_{GS} = 10\text{ V}$	—	12	—	nC
Gate-source charge		$Q_{gs}$	$I_D = 5\text{ A}$	—	8	—	nC
Gate-drain ("miller") charge		$Q_{gd}$		—	4	—	nC

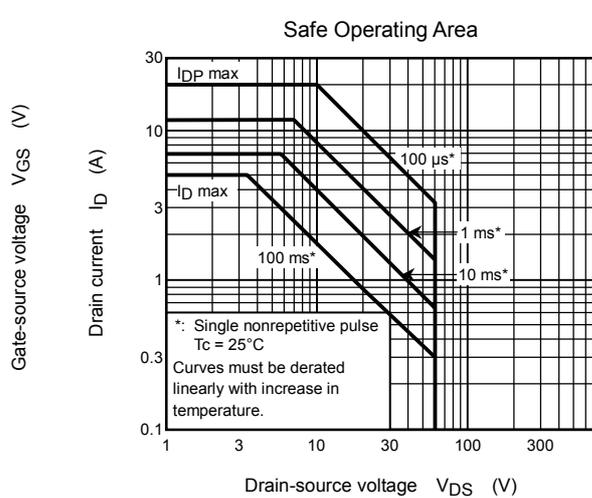
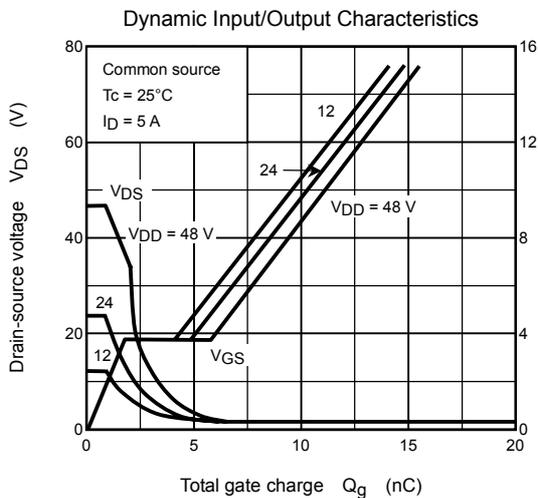
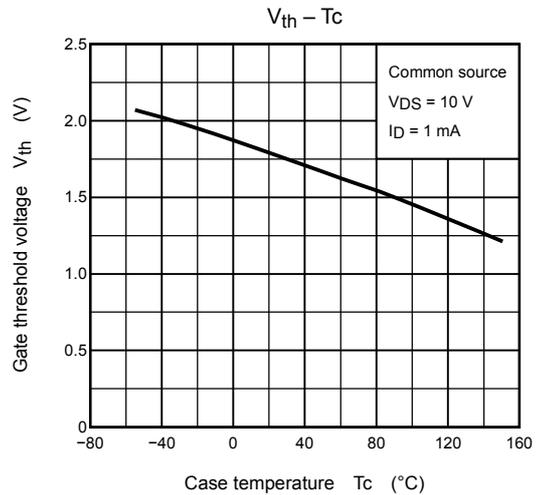
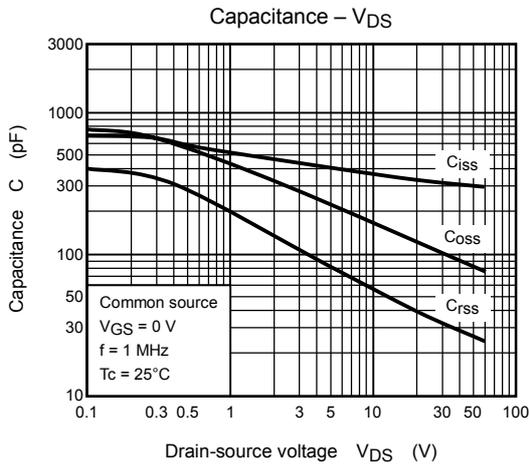
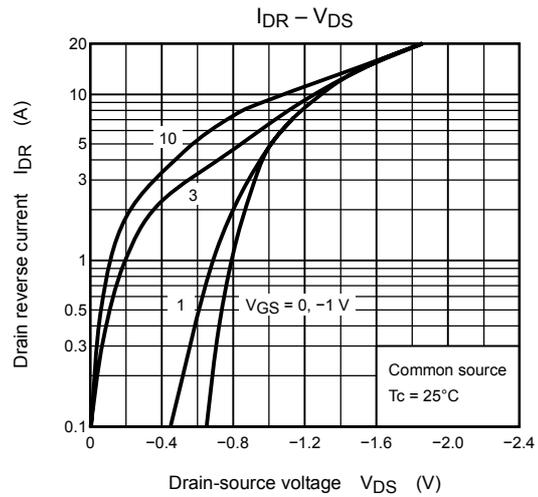
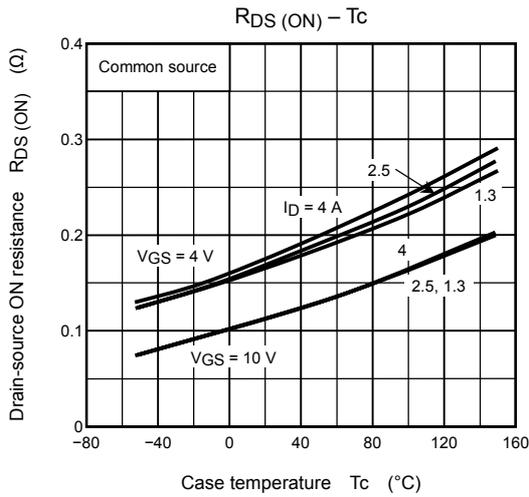
## Source-Drain Diode Ratings and Characteristics (Ta = 25°C)

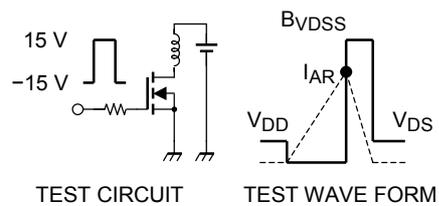
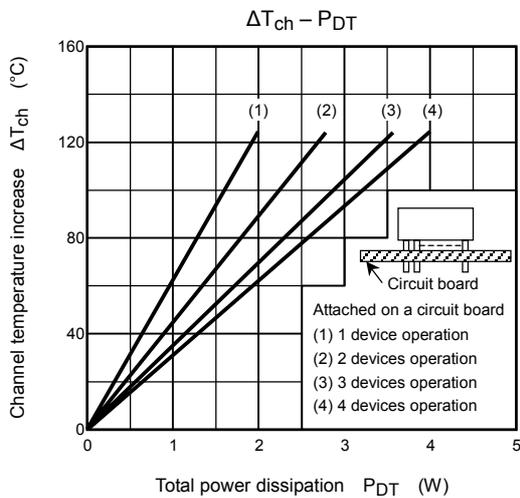
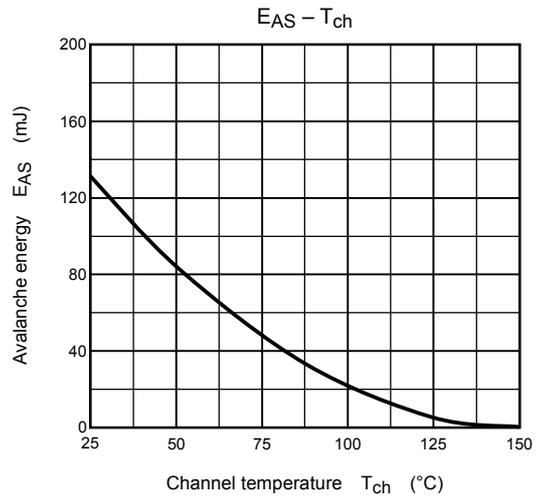
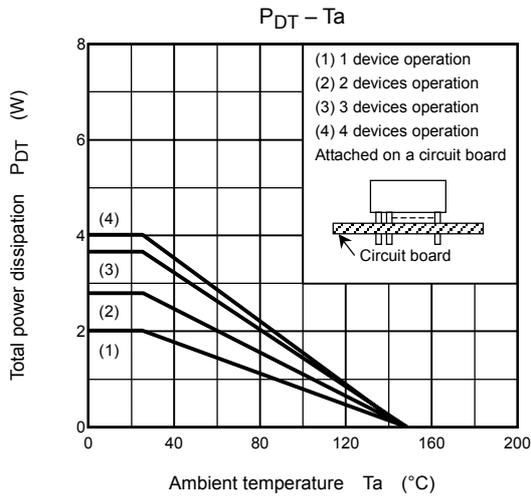
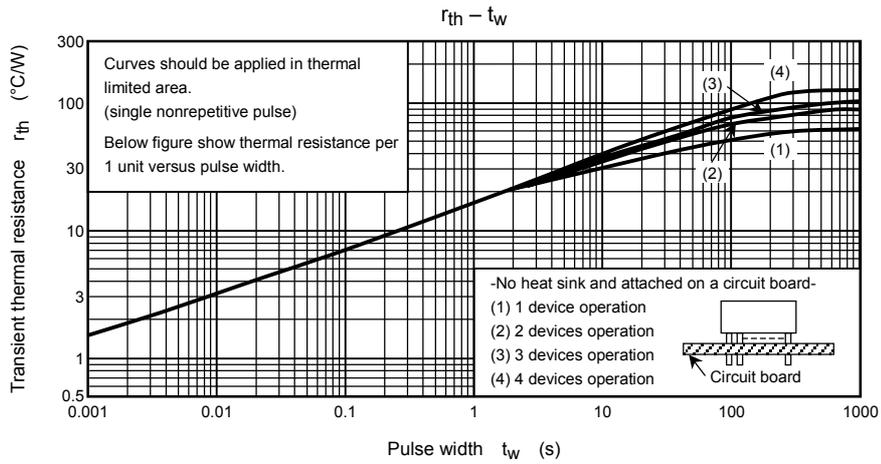
Characteristics	Symbol	Test Condition	Min	Typ.	Max	Unit
Continuous drain reverse current	$I_{DR}$	—	—	—	5	A
Pulse drain reverse current	$I_{DRP}$	—	—	—	20	A
Diode forward voltage	$V_{DSF}$	$I_{DR} = 5\text{ A}, V_{GS} = 0\text{ V}$	—	—	-1.7	V
Reverse recovery time	$t_{rr}$	$I_{DR} = 5\text{ A}, V_{GS} = 0\text{ V}$ $di_{DR}/dt = 50\text{ A}/\mu\text{s}$	—	70	—	ns
Reverse recovery charge	$Q_{rr}$		—	0.1	—	$\mu\text{C}$

## Marking









Peak  $I_{AR} = 5 \text{ A}$ ,  $R_G = 25 \Omega$   
 $V_{DD} = 25 \text{ V}$ ,  $L = 7 \text{ mH}$

$$E_{AS} = \frac{1}{2} \cdot L \cdot I_{AR}^2 \cdot \left( \frac{B_{VDSS}}{B_{VDSS} - V_{DD}} \right)$$

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